

ON Semiconductor®

NDP6020P / NDB6020P P-Channel Logic Level Enhancement Mode Field Effect Transistor

General Description

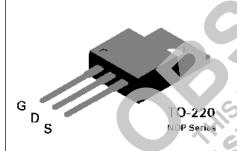
These logic level P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC/DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

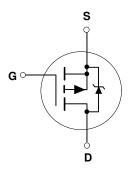
- $\begin{array}{c} \bullet & \text{-24 A, -20 V. R}_{\text{DS(ON)}} = 0.05 \ \Omega \ @\ V_{\text{GS}} = \text{-4.5 V.} \\ R_{\text{DS(ON)}} = 0.07\Omega \ @\ V_{\text{GS}} = \text{-2.7 V.} \\ R_{\text{DS(ON)}} = 0.075 \ \Omega \ @\ V_{\text{GS}} = \text{-2.5 V.} \end{array}$
- Critical DC electrical parameters specified at elevated temperature.
- Ruggeo internal source-drain diode can eliminate the need or an external Zener diode transient suppressor.

175°C maximum junction temperature rating.

- ► High density cell design for extremely low R_{DS(ON)}.
- TO-220 and TO-263 (D²PAK) package for both through hole and surface mount applications.







Absolute Maximum Rating: T_c = 25°C unless otherwise noted

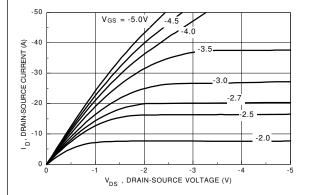
Symbol	Parameter	NDP6020P	NDB6020P	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage - Continuous		±8	V
I _D	Drain Current - Continuous		-24	Α
	- Pulsed		-70	
P _D	Total Power Dissipation @ T _C = 25°C		60	W
	Derate above 25°C		0.4	W/°C
T _J ,T _{STG}	Operating and Storage Temperature Range	-65	to 175	°C

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	ARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-20			V
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$				-1	μΑ
			T _J = 55°C			-10	μΑ
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 8 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAP	RACTERISTICS (Note 1)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-0.4	-0.7	-1	٧
			T _J = 125°C	-0.3	-0.56	-0.7	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, I_{D} = -12 \text{ A}$			0.041	0.05	Ω
			T _J = 125°C		0.06	0.08	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -2.7 \text{ V}, I_{D} = -10 \text{ A}$			0.059	0.07	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -2.5 \text{ V}, I_{D} = -10 \text{ A}$			0.064	0.075	
D(on)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-24			Α
FS	Forward Transconductance	$V_{DS} = -5 \text{ V}, I_{D} = -12 \text{ A}$	<u> </u>		14		S
	CHARACTERISTICS		<u> </u>	2(26		
Siss	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			1590		pF
Coss	Output Capacitance	T = 1.0 MHZ	V.O.		725		pF
Crss	Reverse Transfer Capacitance	5	10 W		215		рF
WITCHI	NG CHARACTERISTICS (Note 1)	001	0 50.				
D(on)	Turn - On Delay Time	$V_{DD} = -20 \text{ V}, I_D = -3 \text{ A},$ $V_{CS} = -5 \text{ V}, R_{GE} = 6 \text{ C}$	181		15	30	nS
	Turn - On Rise Time	$V_{\rm GS} = -5 \text{V}, R_{\rm GEV} = 6 \Omega$	A.		27	60	nS
D(off)	Turn - Off Delay Time	CVO	0,		120	250	nS
· ·	Turn - Off Fall Time				70	150	nS
)	Total Gate Charge	V _{DS} = -10 V,			25	35	nC
) gs	Gate-Source Charge	$I_D = -24 \text{ A}, V_{GS} = -5 \text{ V}$			5		nC
Q_{gd}	Gate-Drain Charge				10		nC
	Gate-Drain Charge	RESERVE					

lodi	Parameter	Conditions	Min	Тур	Max	Units
AIN-S	OURCE DIODE CHARACTERISTICS	•				
	Maximum Continuous Drain-Source Did	de Forward Current			-24	Α
	Maximum Pulsed Drain-Source Diode R	Forward Current			-80	Α
	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = -12 \text{ A (Note 1)}$		-1.1	-1.3	٧
	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_F = -24 \text{ A},$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$		60		ns
	Reverse Recovery Current	$\alpha_{\rm F}/\alpha_{\rm T} = 100 \text{A/}\mu\text{s}$		-1.7		Α
RMA	AL CHARACTERISTICS		<u> </u>			1
;	Thermal Resistance, Junction-to-Case				2.5	°C/V
١	Thermal Resistance, Junction-to-Ambie	nt			62.5	°C/V
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^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

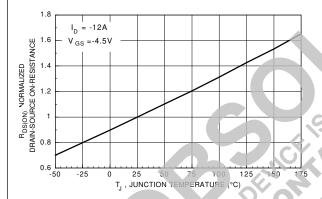
Typical Electrical Characteristics



1.8 V_{GS} = -2.5 V V_{GS} = -2.5 V V_{GS} = -2.5 V V_{GS} = -3.0 V_{GS} = -3.0 V_{GS} = -3.0 V_{GS} = -4.0 V_{GS} =

Figure 1. On-Region Characteristics.

Figure 2. On-Resistance Variation with Gate Voltage and Drain Current.



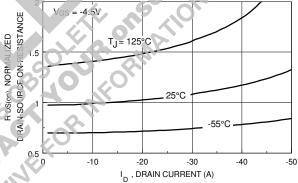
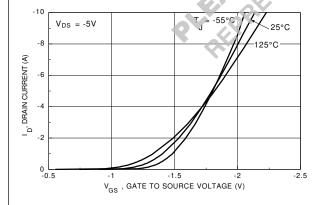


Figure 3. On-Resistance Variation with Temperature.

Figure 4. On-Resistance Variation with Drain Current and Temperature.



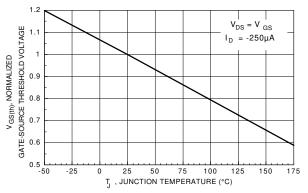


Figure 5. Transfer Characteristics.

Figure 6. Gate Threshold Variation with Temperature.

Typical Electrical Characteristics (continued)

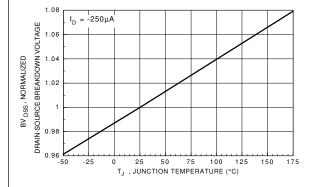


Figure 7. Breakdown Voltage Variation with Temperature.

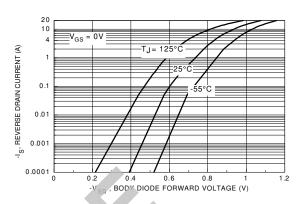


Figure 8. Body Diode Forward Voltage Variation with Current and Temperature.

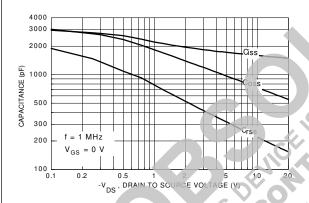


Figure 9. Capacitance Characteristics.

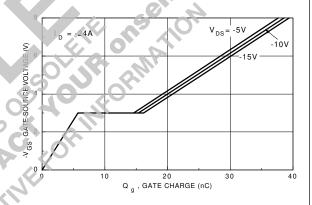


Figure 10. Gate Charge Characteristics.

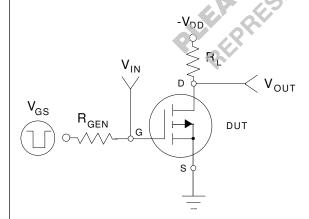


Figure 11. Switching Test Circuit.

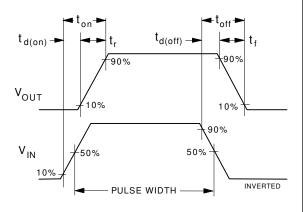
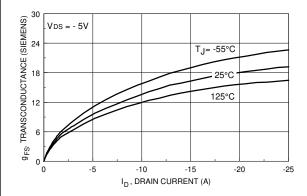


Figure 12. Switching Waveforms.

Typical Electrical Characteristics (continued)



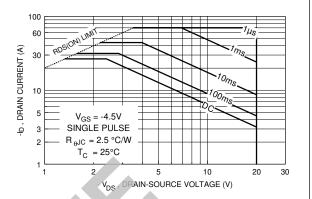


Figure 13. Transconductance Variation with Drain Current and Temperature.

Figure 14. Maximum Safe Operating Area.

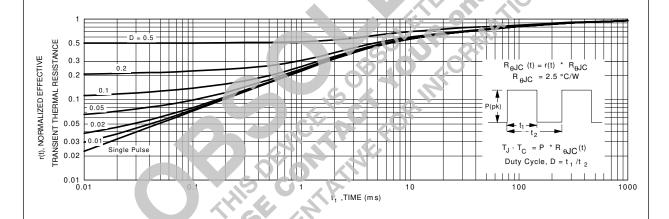


Figure 15. Transient Thermal Response Curve.



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